

Zhen Ding Participates in SEMICON Taiwan for the First Time, Showcasing High-end IC Substrates and AI Server PCBs

Zhen Ding Technology Holding Limited (Ticker: 4958), a global leading PCB manufacturer, participated in SEMICON Taiwan 2024 for the first time during September 4th to 6th. At the “AI Technology Zone,” the company showcased a series of AI-related products, including IC substrates and server PCBs. In addition, Zhen Ding's Director and COO, D.J. Lee, served as a panelist at “3D IC/CoWoS for AI Summit” on September 4th, highlighting the company's significance in the semiconductor supply chain.



Being optimistic about the future prospects of the vast demand for AI applications, Zhen Ding showcased a series of AI-related IC substrates and server PCBs in the exhibition, and two of its senior management delivered speeches at the “Meet the Expert” session. Dr. Yi-Ho Chen presented “Challenges and Opportunities for IC Substrates in the AI Era,” and Assistant Vice President Sarah Yen discussed “Opportunities and Challenges for PCBs Arising from AI Chip Innovations.” Zhen Ding emphasized that high layer counts and high precision PCBs have always been the company's key strengths. In the future, it will leverage the “Cloud, Channel, Device” concept to offer the most comprehensive and advanced PCBs for all kinds of AI applications, maintaining its leadership in the PCB industry.

Additionally, COO D.J. Lee highlighted at “3D IC/CoWoS for AI Summit” that as chip complexity increases and the industry moves toward 3D packaging, the challenges of



IC substrates are growing, and their role in advanced semiconductor processes is becoming increasingly important. That said, Zhen Ding not only provides a comprehensive product portfolio of high-end IC substrates, but also owns the most advanced and highly automated IC substrate fabs, achieving world-leading standards in both quality and yield. Overall, Zhen Ding remains confident that it will become one of the top five global IC substrate manufacturers by 2030.

About Zhen Ding Technology Holding Limited

Zhen Ding Technology Holding Limited (Taiwan Stock Exchange: 4958) specializes in the research, development, production, and sales variety of products, including flexible printed circuit board (FPC) and surface mount assembly (SMA), substrate-like PCBs (SLP), high-density interconnect (HDI) PCBs, ultra-thin Mini LED board, multilayer rigid printed circuit boards (RPCB) and IC substrates (ICS). These products are widely used in end products such as computer information, consumer electronics, communications networks, automotive electronics, AI server high-speed computing, optical module and medical applications. The company offers professional one-stop shopping, full-solution services to customer worldwide. For more detailed information, please visit the company website: www.zdtco.com.

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